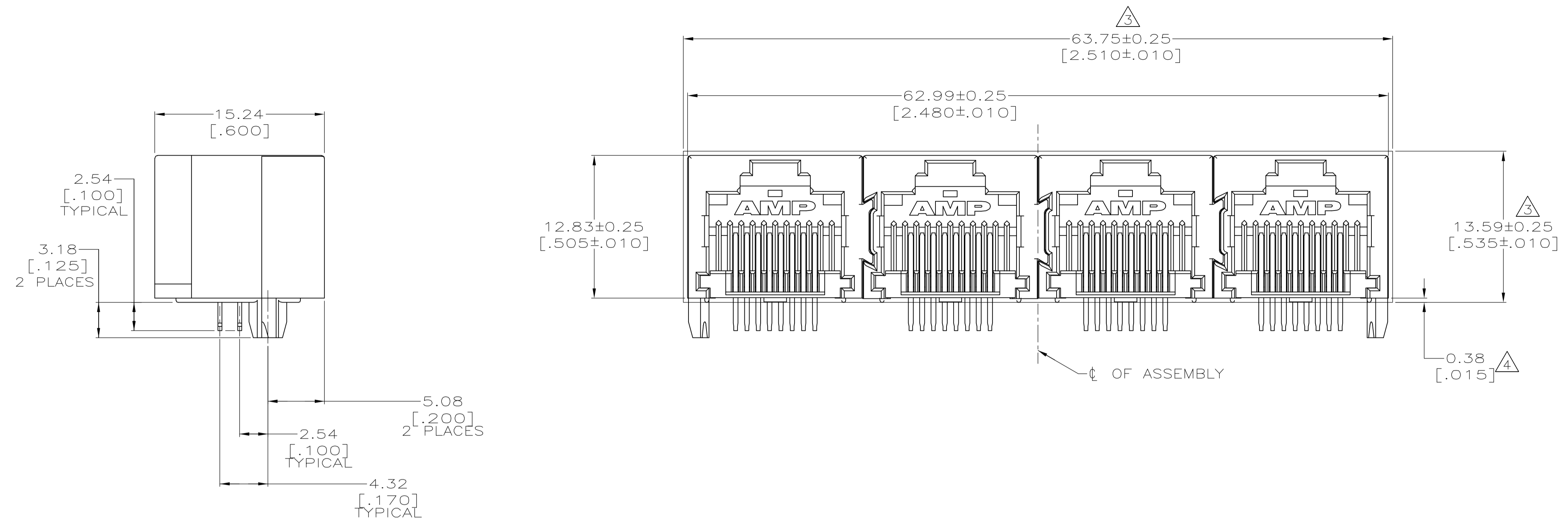
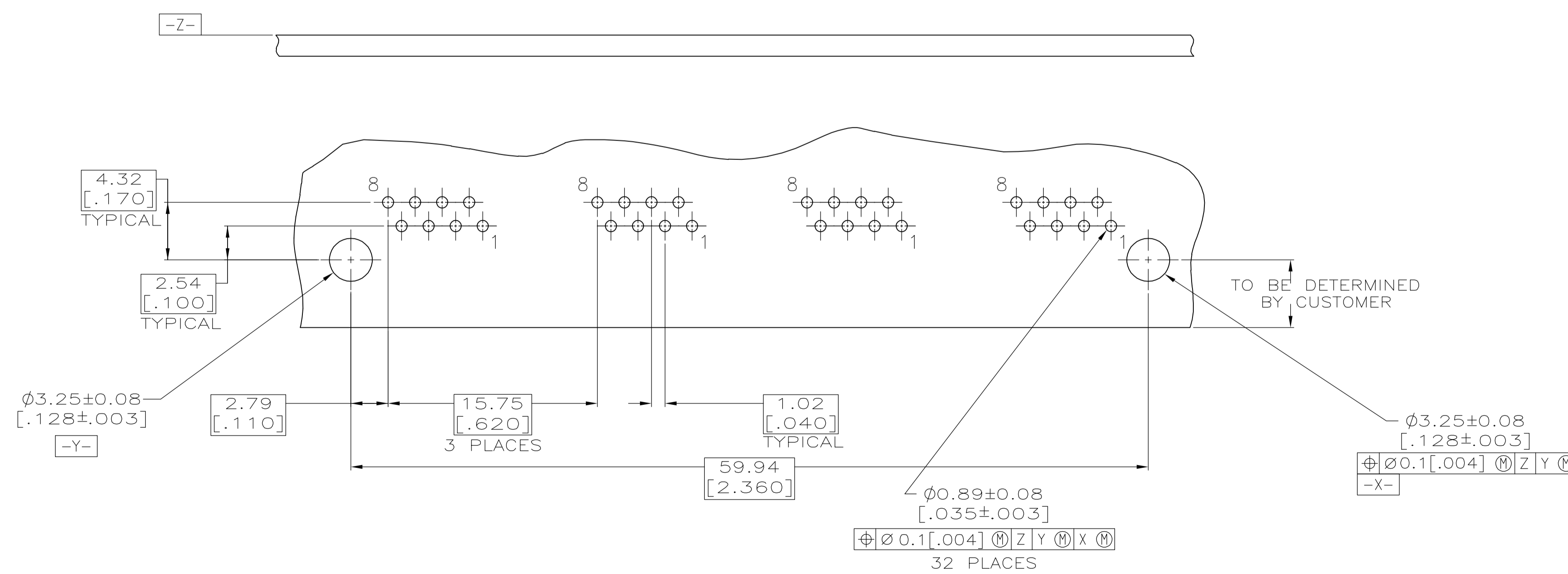


LOC	DIST	REVISIONS			
P	LTR	DESCRIPTION	DATE	OWN	APVD
AA	22	A	REV PER EC 0511-0201-04	10JUN2005	JA SF



- △ MATERIAL:
 HOUSING – HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0; IR REFLOW SOLDERING PROCESS COMPATIBLE.
 TERMINALS – .36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL.
2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
- △ SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 (COMPONENT SIDE)

5406528-1
 PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN J. ALCORTA - 10JUN2005	Tyco Electronics Corporation Harrisburg, PA 17105-3608	
DIMENSIONS: mm[inches]		CHK J. WESTMAN - 10JUN2005	APVD S. FLICKINGER - 10JUN2005	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME		
0 PLC ± -		PRODUCT SPEC		
1 PLC ± -		108-1163-4		
2 PLC ± -		APPLICATION SPEC		
3 PLC ± -		114-2154		
4 PLC ± -		SIZE CAGE CODE DRAWING NO		
ANGLES ± -		A1 - 5406528		
FINISH -		RESTRICTED TO		
MATERIAL △		CUSTOMER DRAWING		
		SCALE 4:1 SHEET 1 OF 1 REV A		

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)